

Contents

1. Sensor Board Details	2
1.1 Test Conditions	2
1.2 Tx Coil and Frequency Parameters	2
1.3 Calibration Register Settings	2
1.4 Sensor Board	3
1.5 Sensor Target	3
2. Measurement Setup	4
2.1 General	4
2.2 Design-Specific Test Setup	4
3. Measurement Results	5
3.1 Angle Error Primary Coil	5
3.2 Magnitude Primary Coil	6
3.3 Gain Primary Coil	7
4. Revision History	8

Figures

Figure 1. Sensor Board	3
Figure 2. Sensor Target	3
Figure 3. Setup	4
Figure 5. Primary Coil Error	5
Figure 7. Primary Coil Magnitude	6
Figure 9. Primary Coil Gain	7

Tables

Table 1. Sensor Characteristics	2
Table 2. Chip Characteristics	2
Table 3. Sensor Characteristics	2
Table 4. Registers Dump	2

1. Sensor Board Details

Table 1. Sensor Characteristics

Design ID	Design Type	Single / High Res / Redundant	Number of Pole Pairs	PCB Size [mm]	Coil Size DOUT / DIN [mm]	Target Size DOUT / DIN [mm]	Air Gap (Nominal) [mm]	Accuracy (Nominal) [deg mech.]
RAA2P3200R0100ABI	Rotary	Single	1	45 x 45	34 / 13	35 / 12	1.60	±0.154

Table 2. Chip Characteristics

Chip	Coil Type	Interface	Internal Resolution
RAA2P3200	Single Coil	ABI	14 Bit

1.1 Test Conditions

- Measurements are done in a lab environment at room temperature.
- The supply voltage level is 5V supplied by the measurement Hardware (VDD = 5V)
- The nominal accuracy is measured @ nominal air gap.
- Inductance and the DC resistance of the TX coil are measured using a Smart Tweezer ST5S LCR Meter.

1.2 Tx Coil and Frequency Parameters

Set C_{TX} transmit frequency between 2.2 and 5.6 MHz. To ensure a high-quality factor, a NP0 capacitor was used. F_{TX} was measured by the RAA2P3200 itself.

Table 3. Sensor Characteristics

L_{TX}	R_L	C_{TX}	F_{TX} meas.
1.4 μ H	1.5 Ω	1750 pF	3.51 MHz

1.3 Calibration Register Settings

The registers up to 0x32 are for the general operation of the chip.

0x34 to 0x6E contain the offset compensation, linearization and zero point.

Registers in the row 0x70 control options for the upper and lower limits of the magnitude and the position range.

The last row contains customer IDs and spare bits and the CRC checksum at 0x8E.

Table 4. Registers Dump

	0x00	0x02	0x04	0x06	0x08	0x0A	0x0C	0x0E
0h	0x10E0	0x8080	0x0000	0x0000	0x0000	0x0000	0x0000	0x0000
10h	0x0000	0x0000	0x0000	0x00D3	0x0FFF	0x0000	0x0107	0x7980
20h	0x6401	0x0000	0xF9FF	0x0000	0x0000	0x0000	0x0000	0x1580
30h	0x6125	0x0000	0x4000	0x4000	0x0000	0x0000	0x0136	0x0000
40h	0x90FA	0xF320	0x3AF2	0xE4D0	0x6455	0x6F86	0x97F7	0x7A9D
50h	0xB6BA	0x1C78	0x72D5	0xF11E	0x90F9	0xF820	0x3B82	0xB4CF
60h	0x5F55	0x6F46	0x57F5	0x7A9D	0xB71A	0xEC78	0x70D4	0xF11E
70h	0x0FFF	0x0000	0x0000	0x0000	0x0000	0x0072	0x3FFF	0x0000
80h	0x0000	0x0000	0x0001	0x0000	0x0000	0x0000	0x0000	0x0EBF

1.4 Sensor Board

Figure 1. displays the sensor board layout, consisting of one transmitter coil, two receiver coils, the RAA2P3200 and additional passive components.

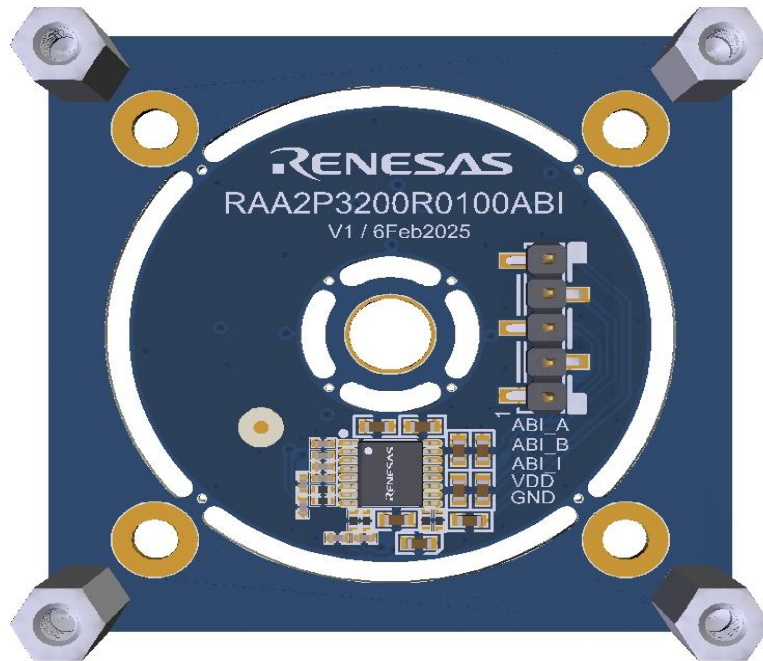


Figure 1. Sensor Board

1.5 Sensor Target

Figure 2. displays the target used during the measurements.



Figure 2. Sensor Target

2. Measurement Setup

2.1 General

All measurements were performed on a 4-axis positioning test bench. During the measurement, the target was moved to a defined position. The rotor position read from the sensor is compared to the rotor position measured by high precision reference encoder.

$$f_{mechanical} = \text{real sensor position} - \text{ideal position value}$$

2.2 Design-Specific Test Setup

Figure 3. displays the test setup, the sensor board and target are mounted on the 4-axis positioning test bench.

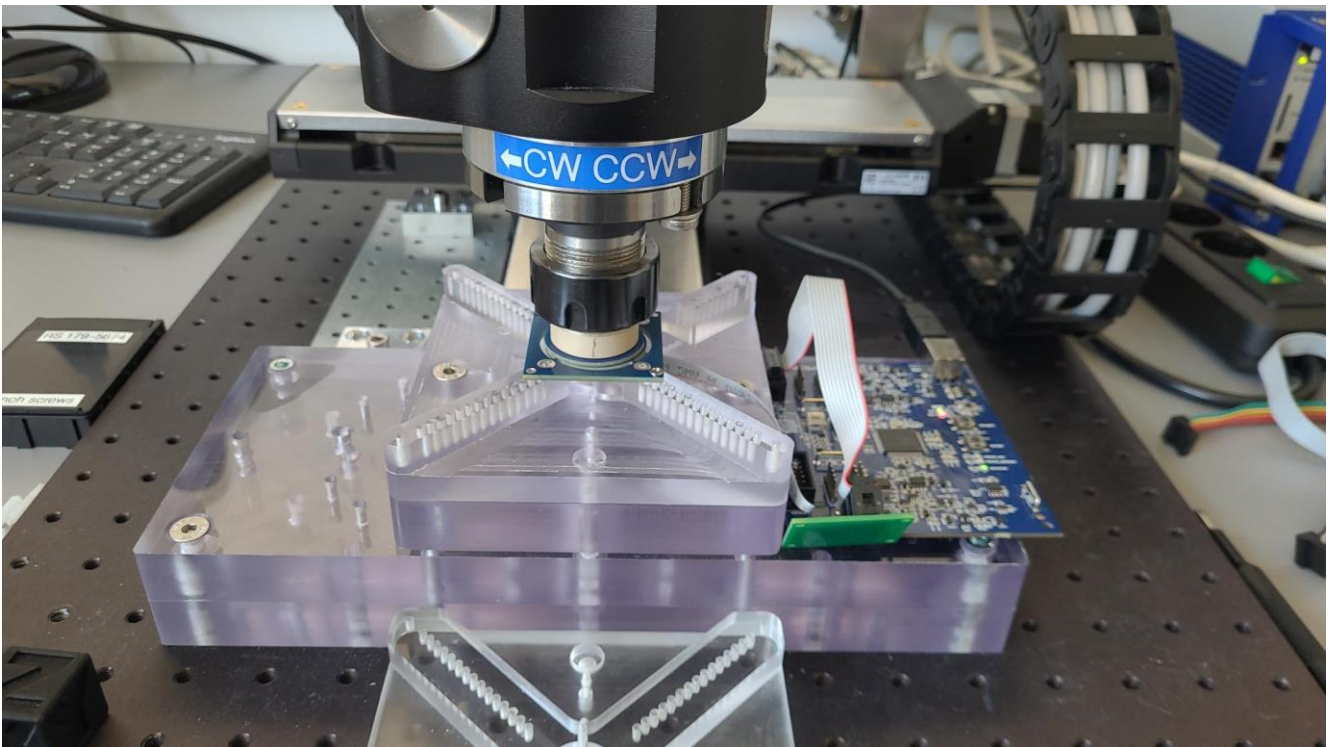


Figure 3. Setup

3. Measurement Results

3.1 Angle Error Primary Coil

The coil offset was compensated without target, then the design was linearized at nominal position. The plot below displays the error of the primary angle measured over the given positions. Measurements are done with the memory settings, as shown in Table 4.

Note: Line Chart Naming: X_._Y_._AG_._

- X = radial displacement in mm
- Y = radial displacement in mm
- AG = Air Gap in mm

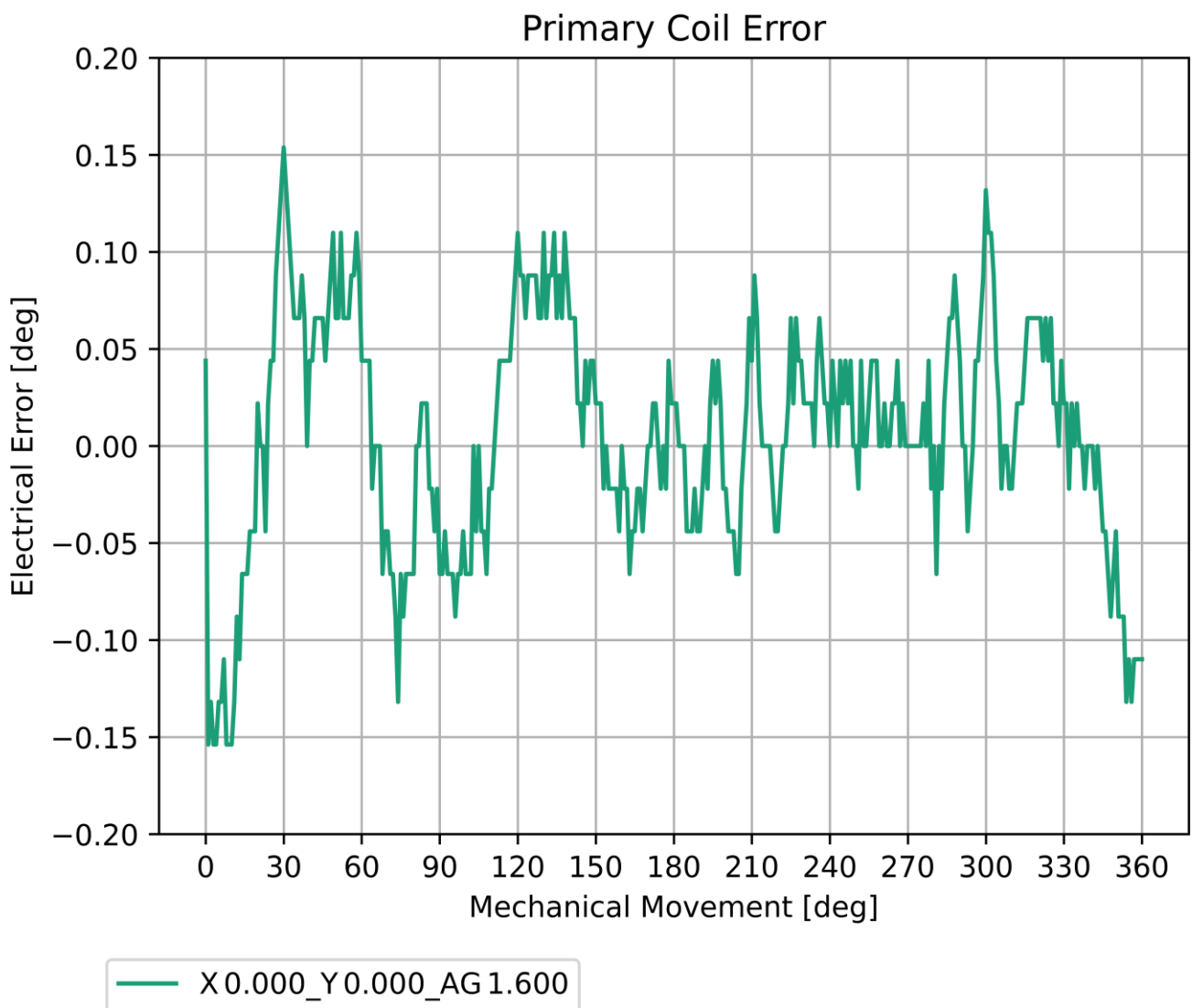


Figure 4. Primary Coil Error

3.2 Magnitude Primary Coil

The plot below displays the primary magnitude measured over the given positions. Measurements are done with the memory settings, as shown in Table 4.

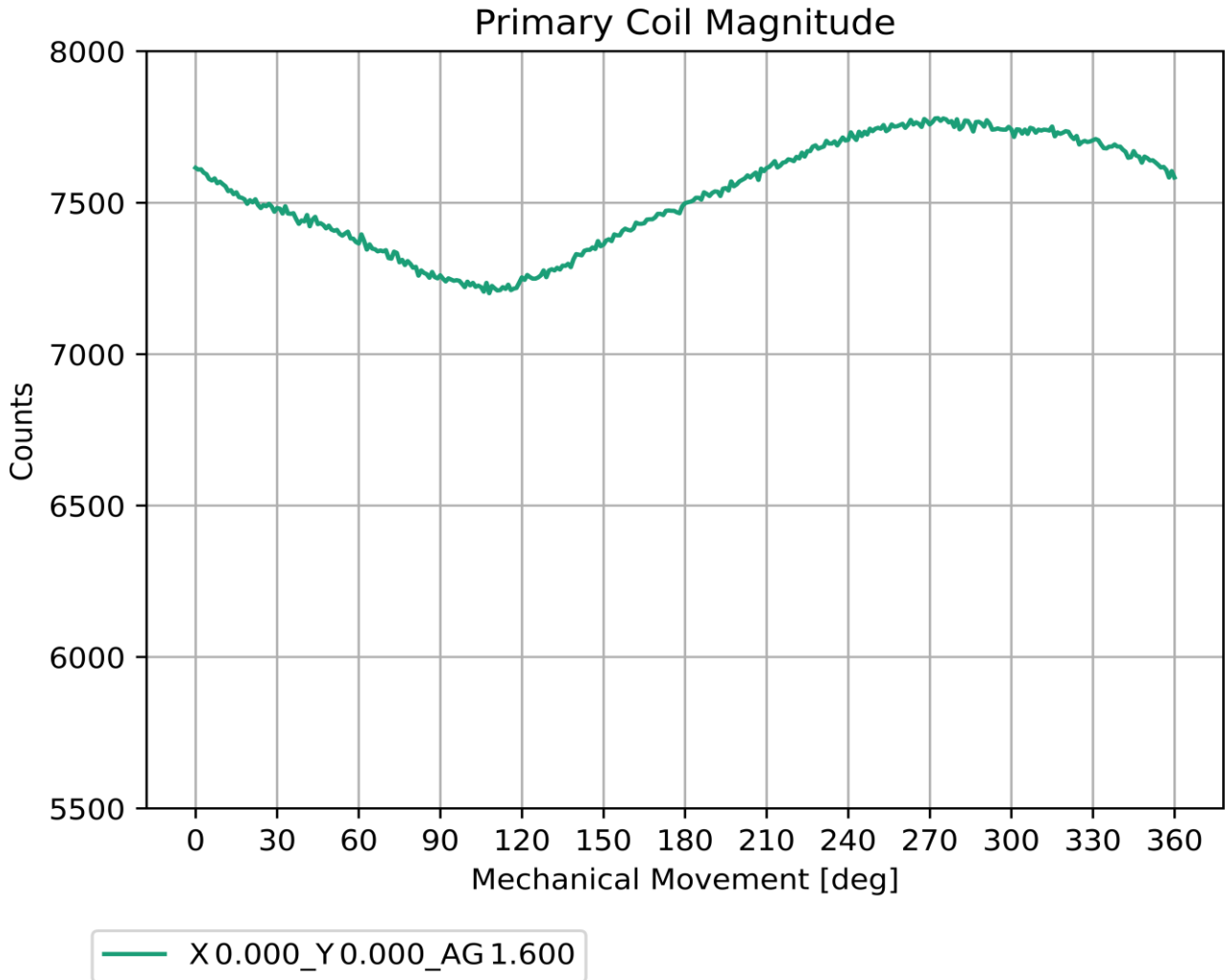


Figure 5. Primary Coil Magnitude

3.3 Gain Primary Coil

The plot below displays the primary coil gain setting measured over the given positions. Measurements are done with the memory settings, as shown in Table 4.

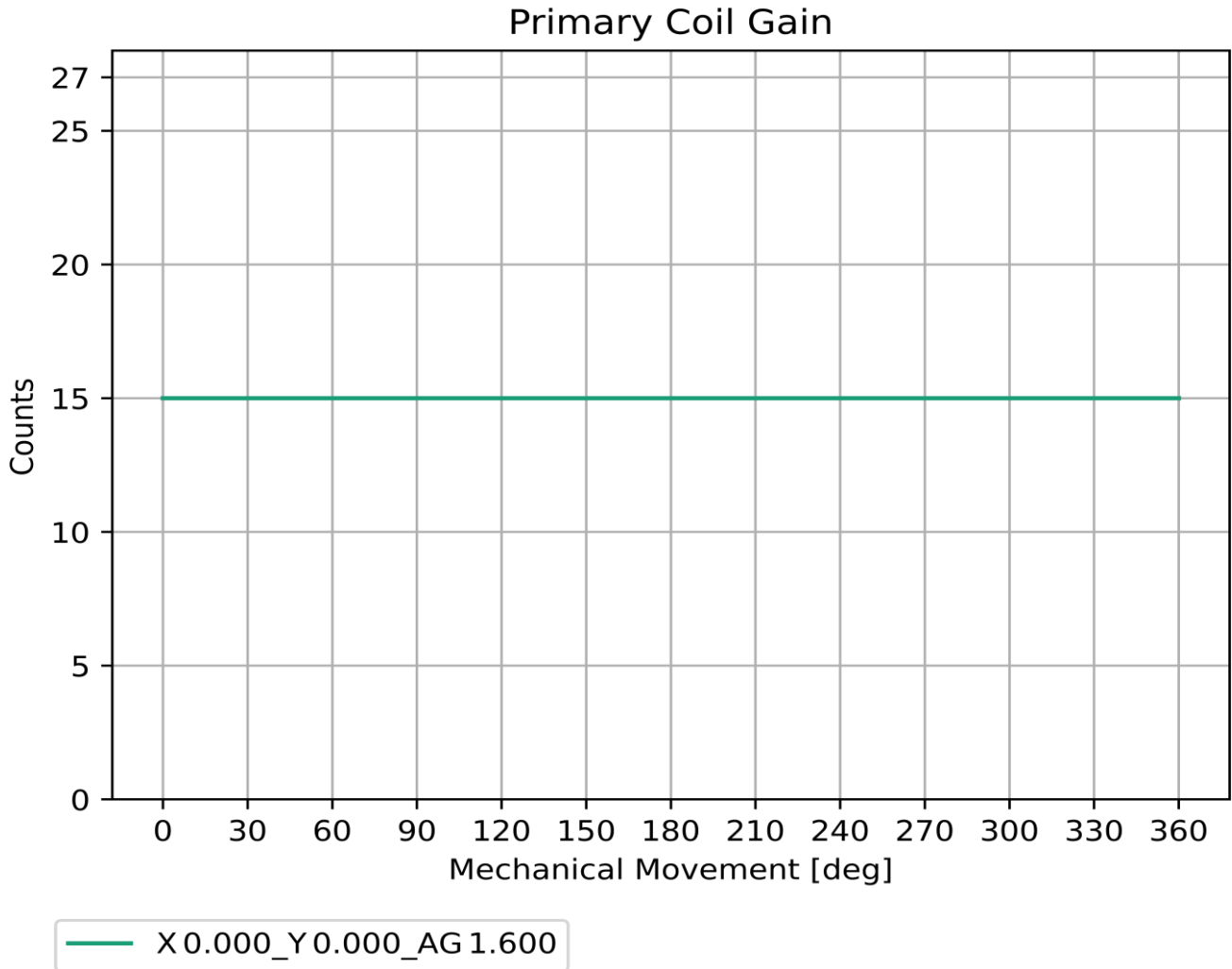


Figure 6. Primary Coil Gain

4. Revision History

Revision	Date	Description
1.0	Oct. 3, 25	Initial release.

Notice

1. Descriptions of circuits, software and other related information in this document are provided only to illustrate the operation of semiconductor products and application examples. You are fully responsible for the incorporation or any other use of the circuits, software, and information in the design of your product or system. Renesas Electronics disclaims any and all liability for any losses and damages incurred by you or third parties arising from the use of these circuits, software, or information.
2. Renesas Electronics hereby expressly disclaims any warranties against and liability for infringement or any other claims involving patents, copyrights, or other intellectual property rights of third parties, by or arising from the use of Renesas Electronics products or technical information described in this document, including but not limited to, the product data, drawings, charts, programs, algorithms, and application examples.
3. No license, express, implied or otherwise, is granted hereby under any patents, copyrights or other intellectual property rights of Renesas Electronics or others.
4. You shall be responsible for determining what licenses are required from any third parties, and obtaining such licenses for the lawful import, export, manufacture, sales, utilization, distribution or other disposal of any products incorporating Renesas Electronics products, if required.
5. You shall not alter, modify, copy, or reverse engineer any Renesas Electronics product, whether in whole or in part. Renesas Electronics disclaims any and all liability for any losses or damages incurred by you or third parties arising from such alteration, modification, copying or reverse engineering.
6. Renesas Electronics products are classified according to the following two quality grades: "Standard" and "High Quality". The intended applications for each Renesas Electronics product depends on the product's quality grade, as indicated below.
 - "Standard": Computers; office equipment; communications equipment; test and measurement equipment; audio and visual equipment; home electronic appliances; machine tools; personal electronic equipment; industrial robots; etc.
 - "High Quality": Transportation equipment (automobiles, trains, ships, etc.); traffic control (traffic lights); large-scale communication equipment; key financial terminal systems; safety control equipment; etc.
- Unless expressly designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not intended or authorized for use in products or systems that may pose a direct threat to human life or bodily injury (artificial life support devices or systems; surgical implantations; etc.), or may cause serious property damage (space system; undersea repeaters; nuclear power control systems; aircraft control systems; key plant systems; military equipment; etc.). Renesas Electronics disclaims any and all liability for any damages or losses incurred by you or any third parties arising from the use of any Renesas Electronics product that is inconsistent with any Renesas Electronics data sheet, user's manual or other Renesas Electronics document.
7. No semiconductor product is absolutely secure. Notwithstanding any security measures or features that may be implemented in Renesas Electronics hardware or software products, Renesas Electronics shall have absolutely no liability arising out of any vulnerability or security breach, including but not limited to any unauthorized access to or use of a Renesas Electronics product or a system that uses a Renesas Electronics product. RENESAS ELECTRONICS DOES NOT WARRANT OR GUARANTEE THAT RENESAS ELECTRONICS PRODUCTS, OR ANY SYSTEMS CREATED USING RENESAS ELECTRONICS PRODUCTS WILL BE INVULNERABLE OR FREE FROM CORRUPTION, ATTACK, VIRUSES, INTERFERENCE, HACKING, DATA LOSS OR THEFT, OR OTHER SECURITY INTRUSION ("Vulnerability Issues"). RENESAS ELECTRONICS DISCLAIMS ANY AND ALL RESPONSIBILITY OR LIABILITY ARISING FROM OR RELATED TO ANY VULNERABILITY ISSUES. FURTHERMORE, TO THE EXTENT PERMITTED BY APPLICABLE LAW, RENESAS ELECTRONICS DISCLAIMS ANY AND ALL WARRANTIES, EXPRESS OR IMPLIED, WITH RESPECT TO THIS DOCUMENT AND ANY RELATED OR ACCOMPANYING SOFTWARE OR HARDWARE, INCLUDING BUT NOT LIMITED TO THE IMPLIED WARRANTIES OF MERCHANTABILITY, OR FITNESS FOR A PARTICULAR PURPOSE.
8. When using Renesas Electronics products, refer to the latest product information (data sheets, user's manuals, application notes, "General Notes for Handling and Using Semiconductor Devices" in the reliability handbook, etc.), and ensure that usage conditions are within the ranges specified by Renesas Electronics with respect to maximum ratings, operating power supply voltage range, heat dissipation characteristics, installation, etc. Renesas Electronics disclaims any and all liability for any malfunctions, failure or accident arising out of the use of Renesas Electronics products outside of such specified ranges.
9. Although Renesas Electronics endeavors to improve the quality and reliability of Renesas Electronics products, semiconductor products have specific characteristics, such as the occurrence of failure at a certain rate and malfunctions under certain use conditions. Unless designated as a high reliability product or a product for harsh environments in a Renesas Electronics data sheet or other Renesas Electronics document, Renesas Electronics products are not subject to radiation resistance design. You are responsible for implementing safety measures to guard against the possibility of bodily injury, injury or damage caused by fire, and/or danger to the public in the event of a failure or malfunction of Renesas Electronics products, such as safety design for hardware and software, including but not limited to redundancy, fire control and malfunction prevention, appropriate treatment for aging degradation or any other appropriate measures. Because the evaluation of microcomputer software alone is very difficult and impractical, you are responsible for evaluating the safety of the final products or systems manufactured by you.
10. Please contact a Renesas Electronics sales office for details as to environmental matters such as the environmental compatibility of each Renesas Electronics product. You are responsible for carefully and sufficiently investigating applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive, and using Renesas Electronics products in compliance with all these applicable laws and regulations. Renesas Electronics disclaims any and all liability for damages or losses occurring as a result of your noncompliance with applicable laws and regulations.
11. Renesas Electronics products and technologies shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable domestic or foreign laws or regulations. You shall comply with any applicable export control laws and regulations promulgated and administered by the governments of any countries asserting jurisdiction over the parties or transactions.
12. It is the responsibility of the buyer or distributor of Renesas Electronics products, or any other party who distributes, disposes of, or otherwise sells or transfers the product to a third party, to notify such third party in advance of the contents and conditions set forth in this document.
13. This document shall not be reprinted, reproduced or duplicated in any form, in whole or in part, without prior written consent of Renesas Electronics.
14. Please contact a Renesas Electronics sales office if you have any questions regarding the information contained in this document or Renesas Electronics products.

(Note1) "Renesas Electronics" as used in this document means Renesas Electronics Corporation and also includes its directly or indirectly controlled subsidiaries.

(Note2) "Renesas Electronics product(s)" means any product developed or manufactured by or for Renesas Electronics.

(Disclaimer Rev.5.0-1)

Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,
Koto-ku, Tokyo 135-0061, Japan
www.renesas.com

Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.

Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit:
www.renesas.com/contact/